

VLSI Design EE 523 Spring 2025

Shahid Masud

Lecture 24

Topics for lecture 24



- Arbiter Circuit
- Sources of Clock Jitter and Clock Skew
 - How Jitter and Skew affects Timing in Sequential Circuits
- Sequencing using Flipflops and Latches
- Timing parameters associated with:
 - Combinational Logic
 - Flip flops
 - Latches (two phase and pulsed latch)
- Max Delay and Min Delay determination for Flip flops and Latches
- Looked at some I/O Pad Designs
- QUIZ 5 in next lecture

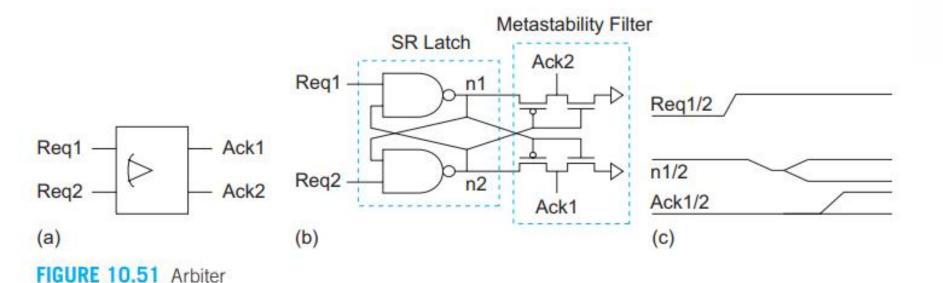
Arbiter Circuit



10.6.5 Arbiters

The arbiter of Figure 10.51(a) is closely related to the synchronizer.

It determines which of two inputs arrived first. If the spacing
between the inputs exceeds some aperture time, the first input should be acknowledged. If
the spacing is smaller, exactly one of the two inputs should be acknowledged, but the
choice is arbitrary. For example, in a television game show, two contestants may pound
buttons to answer a question. If one presses the button first, she should be acknowledged.
If both press the button at times too close to distinguish, the host may choose one of the
two contestants arbitrarily (but must not lock up or catch on fire).



Request 2 Grant 1
Grant 2

FIG: 2 bit input arbiter circuit

Table 1: Truth table of two Bit input asynchronous arbiter.

INPUT		OUTPUT	
Request (R1)	Request (R2)	Grant (G1)	Grant(G2)
0	0	illegal input	
0	1	0	1
1	0	1	0
1	1	illegal input	

Latches and Flipflops



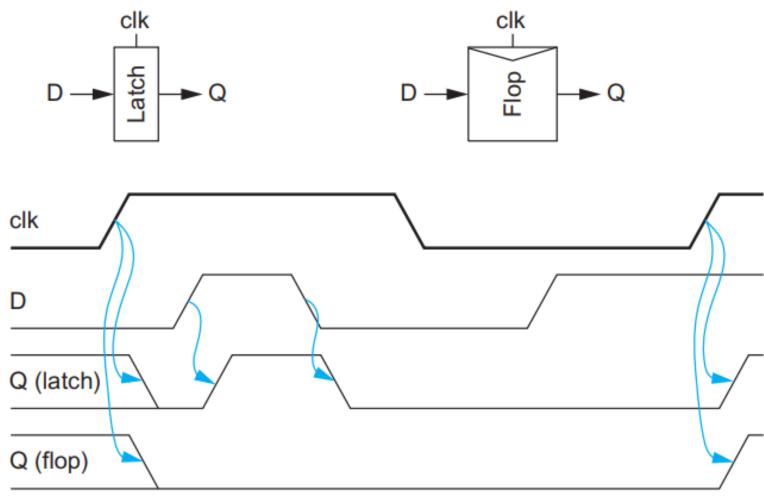
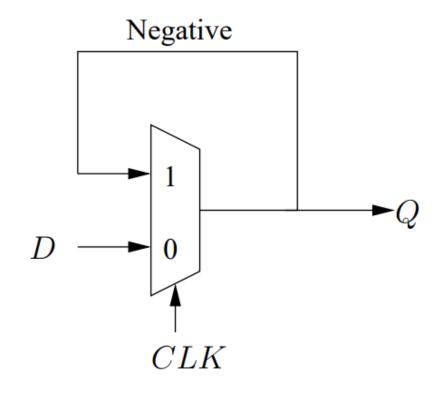


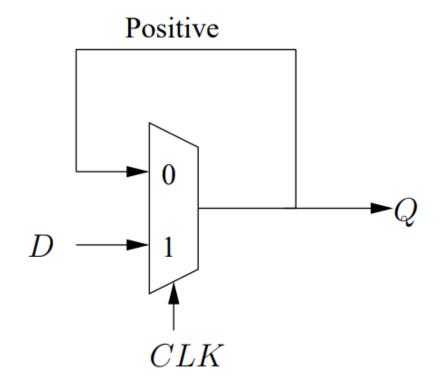
FIGURE 10.1 Latches and flip-flops

Mux Based Latches



Multiplexer Based Latches





Edge Triggered Pass Transistor DFF



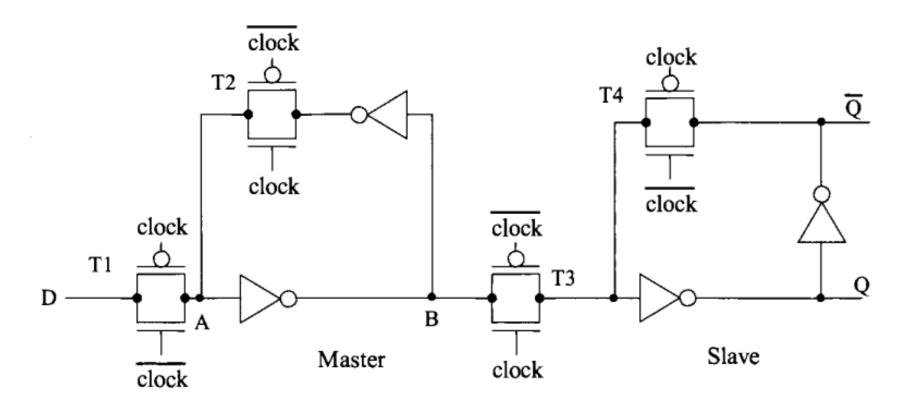
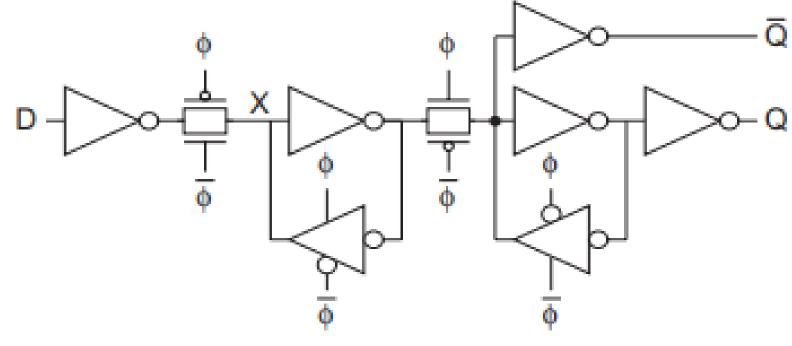


Figure 13.22 An edge-triggered D-FF.

Another DFF using Switches and Inverters





(b)

FIGURE 10.19 Flip-flops

Edge Triggered DFF with Asynch Set and Clear



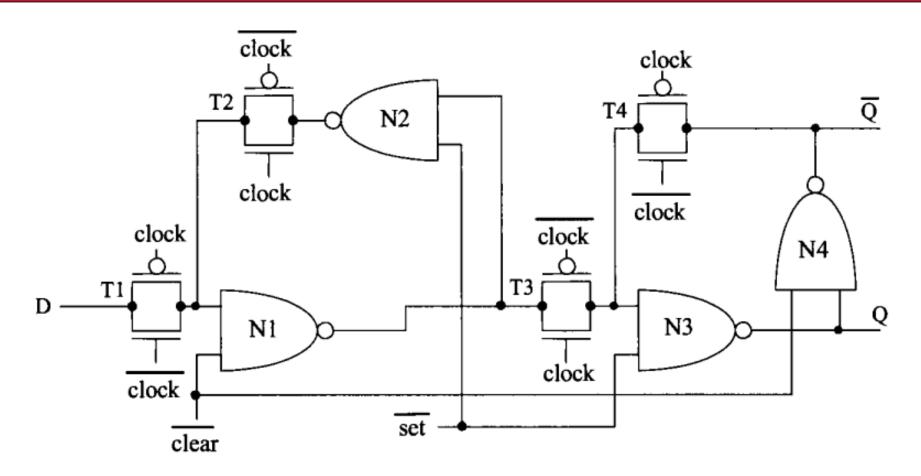
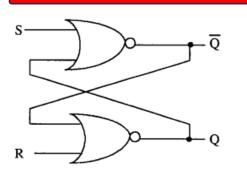


Figure 13.24 An edge-triggered FF with asynchrounous set and clear.

SR Latch to D Flipflop





Truth table

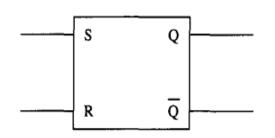
S R Q Q

0 0 Q Q

1 0 1 0

0 1 0 1

1 1 0 0



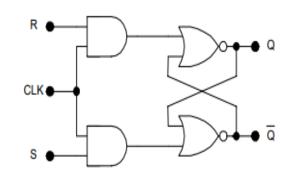


Figure 13.16 Logic symbol of the SR flip-flop.

Figure 13.15 Set-reset flip-flop made using NOR gates.

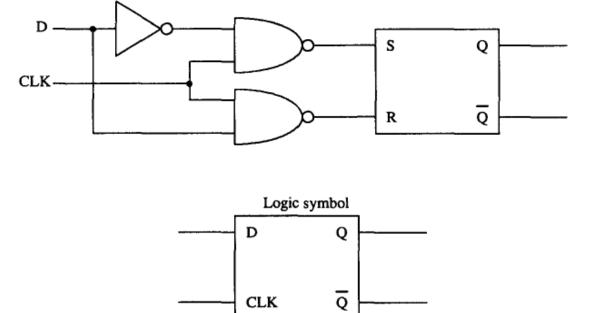
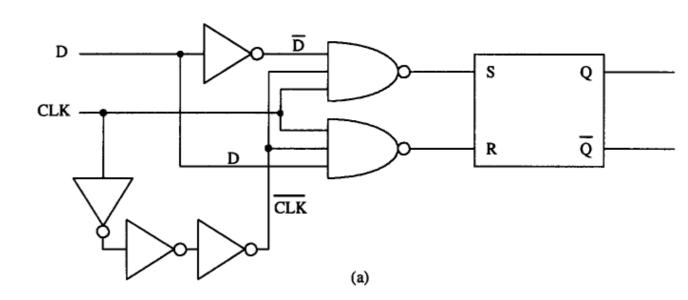


Figure 13.18 Level-sensitive D flip-flop.

FIGURE 15.9 Clocked RS flip-flop.

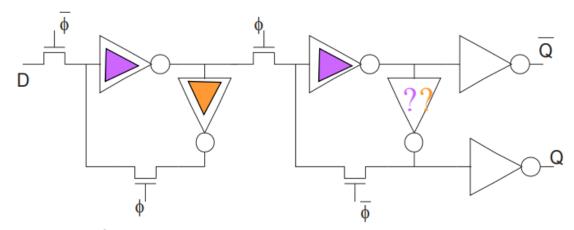


Transistor Sizing in Flip Flops



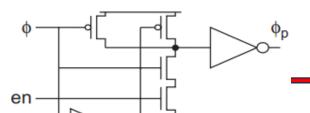
Transistor Sizing in Flip Flops

- · All Minimum-Size Tx Flip Flops
 - will not be optimized for speed
 - might have some output glitches
 - but much more simple to lay out

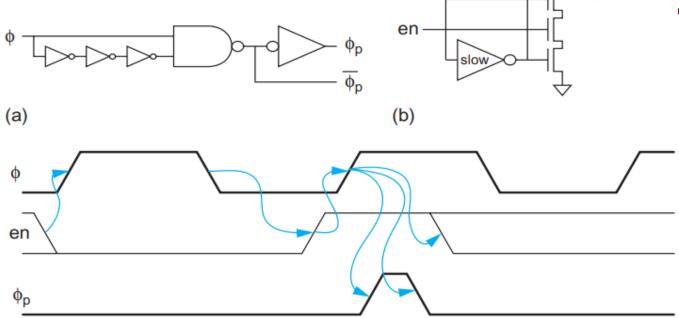


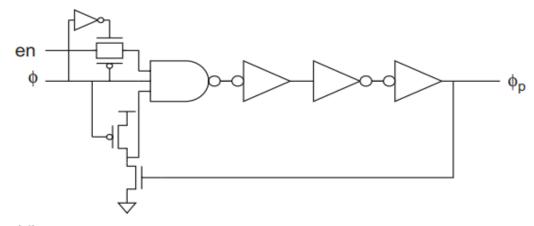
- Size Considerations
 - varies widely with chosen FF design
- feedback INV can be weak
 - tx in direct path to signal output should be larger
 - switches -typically minimum sized to reduce noise

Pulse Generators







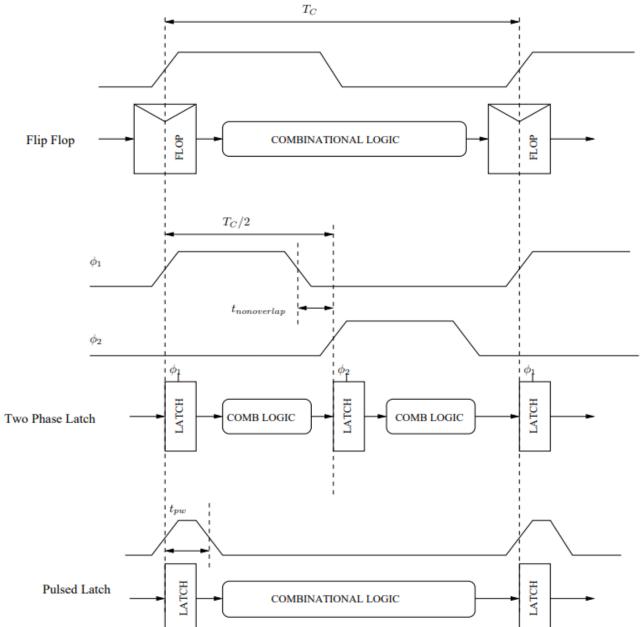


(d)

(c)

Sequencing Sequencing Methods





Timing Notation Table



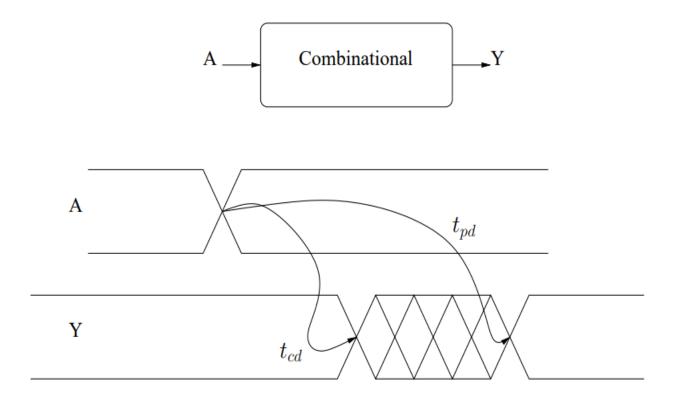
TABLE 10.1 Sequencing element timing notation

Term	Name
t_{pd}	Logic Propagation Delay
t_{cd}	Logic Contamination Delay
t_{pcq}	Latch/Flop Clock-to-Q Propagation Delay
t_{ccq}	Latch/Flop Clock-to-Q Contamination Delay
t_{pdq}	Latch D -to- Q Propagation Delay
t_{cdq}	Latch D -to- Q Contamination Delay
t _{setup}	Latch/Flop Setup Time
t _{hold}	Latch/Flop Hold Time

Logic Delay Combinational Logic Delay



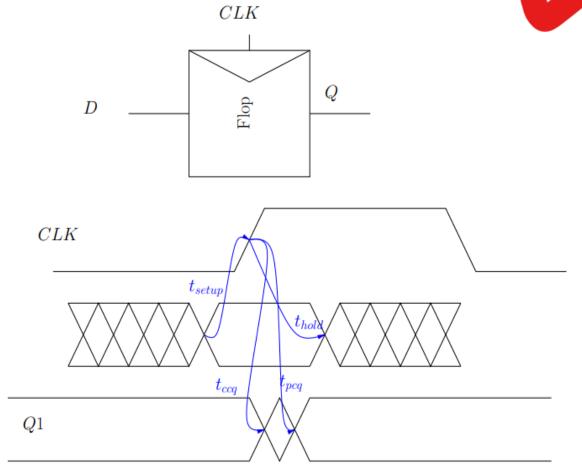




- $ightharpoonup t_{cd}$ Contamination delay Min delay through the circuit
- $ightharpoonup t_{pd}$ Propagation delay Max delay through the circuit

Flip Flop Delay Flip Flop Delay



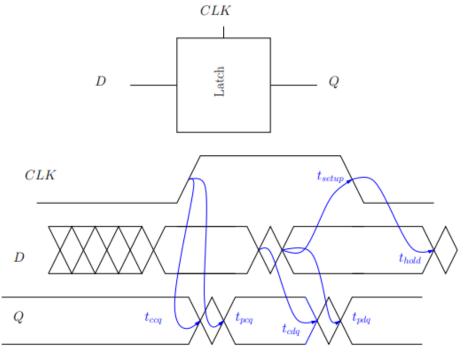


- ► t_{ccq} Contamination Clock-Q delay
- ► t_{pcq} Propagation Clock-Q delay
- ► *t_{setup}* Set up time
- ▶ t_{hold} Hold time

Latch Delay

Latch Delay



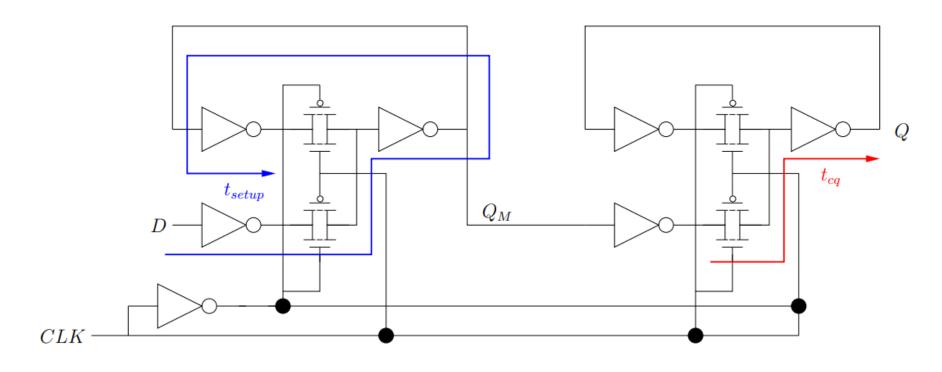


- $ightharpoonup t_{ccq}$ Contamination Clock-Q delay
- ▶ t_{pcq} Propagation Clock-Q delay
- $ightharpoonup t_{cdq}$ Contamination D-Q delay
- $ightharpoonup t_{pdq}$ Propagation D-Q delay
- ► *t_{setup}* Set up time
- ► *t_{hold}* Hold time

MUX Based DFF – Setup and Hold Timing



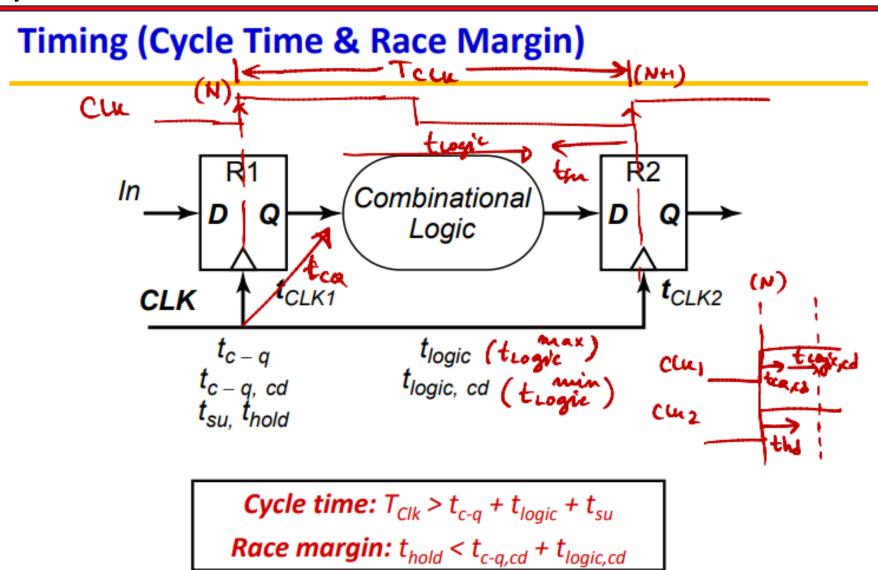
Multiplexer Based Flop - Setup and Hold Times



$$t_{setup} = 3t_{inv-pd} + t_{tx-pd}$$
 $t_{cq} = t_{pd-tx} + t_{pd-inv}$ $t_{hold} = 0$

Timing Cycle



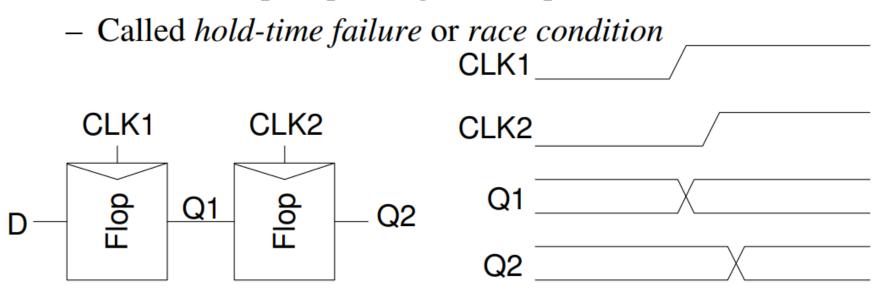


RACE Condition



Race Condition

- Back-to-back flops can malfunction from clock skew
 - Second flip-flop fires late
 - Sees first flip-flop change and captures its result



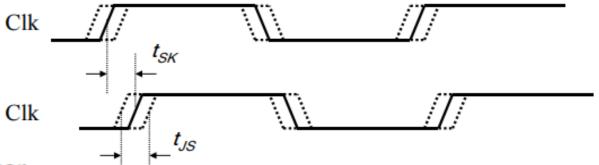
Non-Ideal Clock



Clock Nonidealities

Clock skew

Spatial variation in temporally equivalent clock edges;
 deterministic + random, t_{SK}



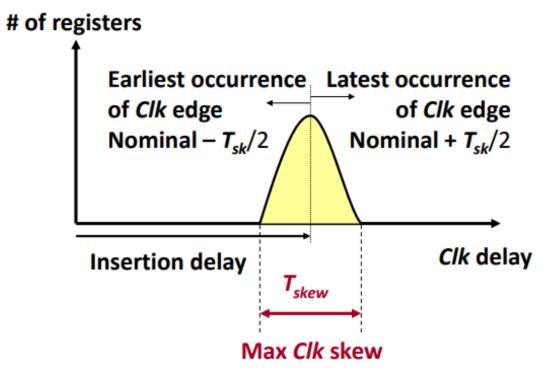
- Clock jitter
 - Temporal variations in consecutive edges of the clock signal;
 modulation + random noise
- Variation of the pulse width
 - For level-sensitive clocking

Clock Skew



Clock Skew

Distribution of clock tree insertion delay

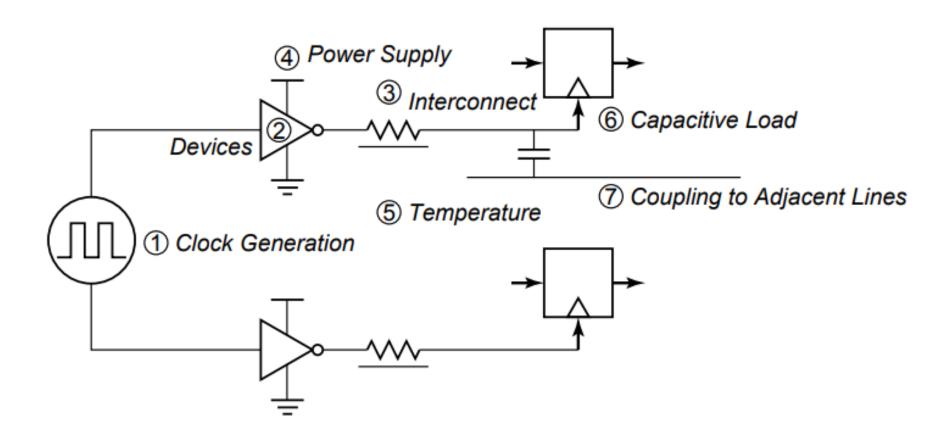




Sources of Skew and Jitter



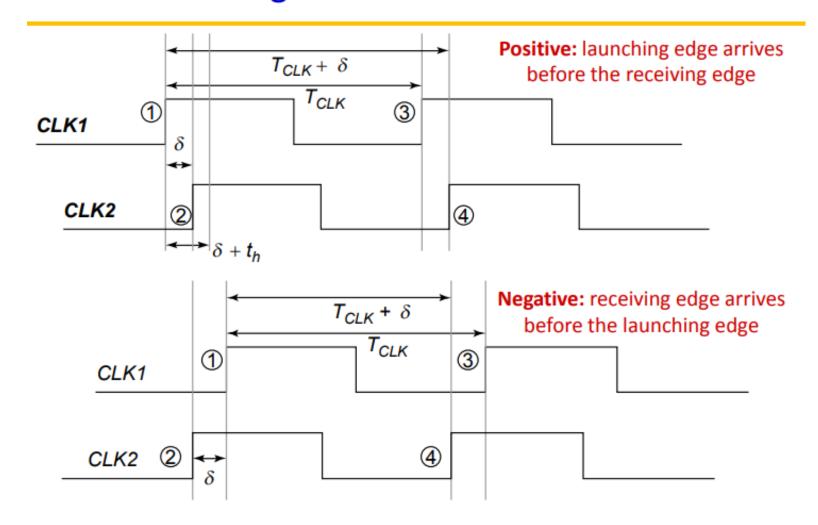
Sources of Skew and Jitter



Positive and Negative Skew



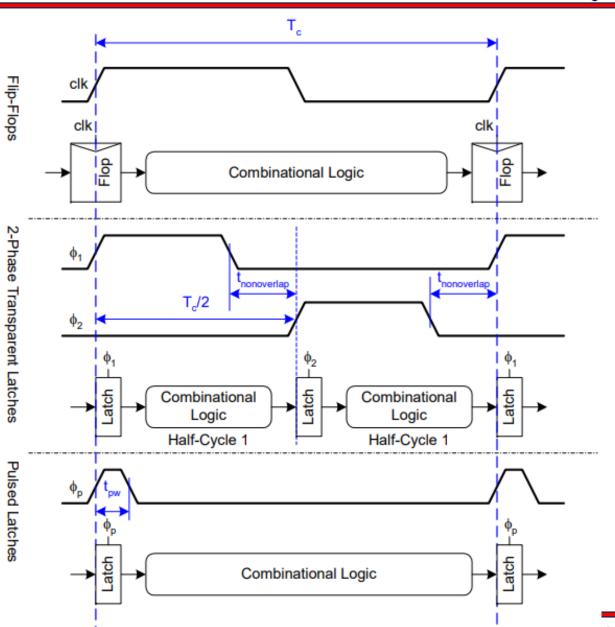
Positive and Negative Skew



Data Sequencing Methods

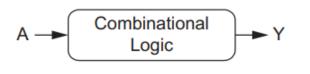


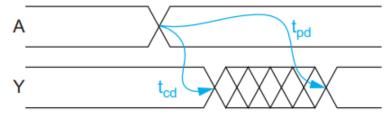
- □ Flip-flops
- 2-Phase Latches
- Pulsed Latches



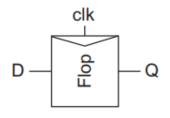
Timing Diagrams with Notations

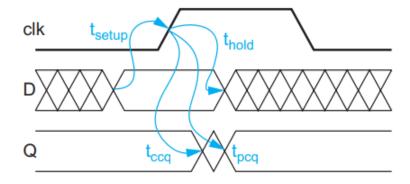




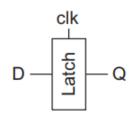


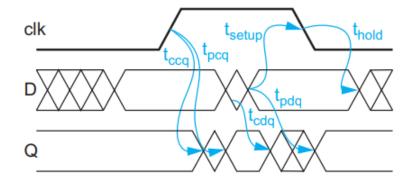
(a)





(b)





(c)

Input Timing Constraints

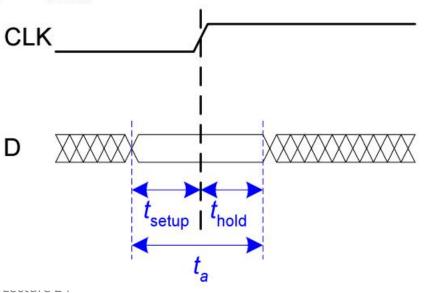


Input Timing Constraints

- Setup time: t_{setup} = time *before* the clock edge that data must be stable (i.e. not changing)
- Hold time: t_{hold} = time *after* the clock edge that data must be stable
- Aperture time: t_a = time around clock edge that data must be stable (t_a = t_{setup} + t_{hold})

Dynamic Discipline

- The input to a synchronous sequential circuit must be stable during the aperture (setup and hold) time around the clock edge.
- Specifically, the input must be stable
 - at least t_{setup} before the clock edge
 - at least until t_{hold} after the clock edge



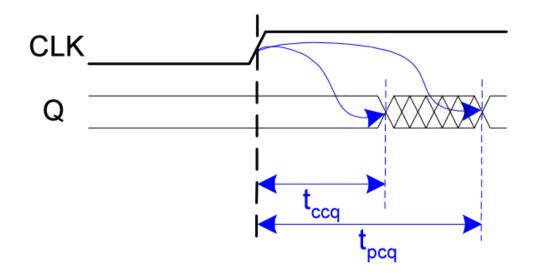


Output Timing Constraints



Output Timing Constraints

- Propagation delay: t_{pcq} = time after clock edge that the output Q is guaranteed to be stable (i.e., to stop changing)
- Contamination delay: t_{ccq} = time after clock edge that Q might be unstable (i.e., start changing)

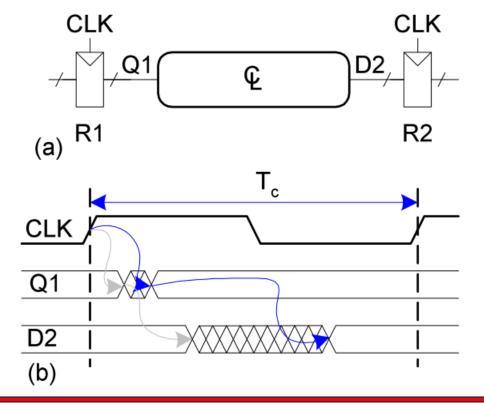


Dynamic Delay Discipline



Dynamic Discipline

 The delay between registers has a minimum and maximum delay, dependent on the delays of the circuit elements

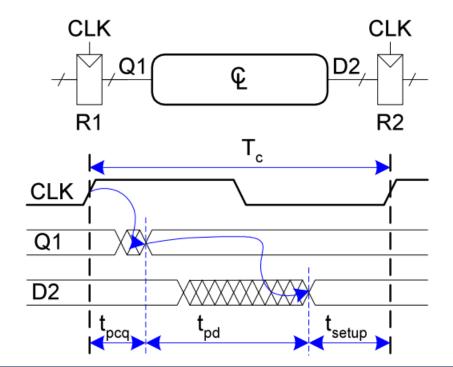


Setup Time Constraints



Setup Time Constraint

- The setup time constraint depends on the **maximum** delay from register R1 through the combinational logic.
- The input to register R2 must be stable at least t_{setup} before the clock edge.



$$T_c \ge t_{pcq} + t_{pd} + t_{\text{setup}}$$
$$t_{pd} \le T_c - (t_{pcq} + t_{\text{setup}})$$

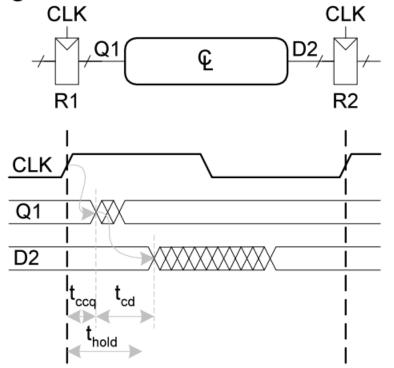


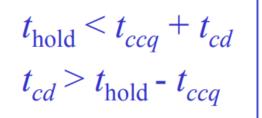
Hold Time Constraints



Hold Time Constraint

- The hold time constraint depends on the **minimum** delay from register R1 through the combinational logic.
- The input to register R2 must be stable for at least t_{hold} after the clock edge.

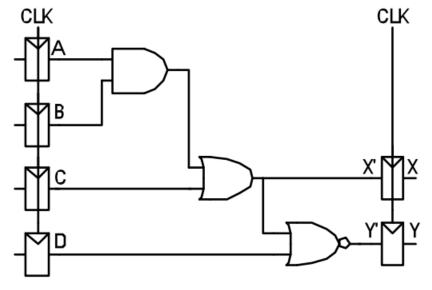




Example of Timing Analysis



Timing Analysis



Timing Characteristics

$$t_{ccq}$$
 = 30 ps

$$t_{pcq}$$
 = 50 ps

$$t_{\text{setup}}$$
 = 60 ps

$$t_{\text{hold}} = 70 \text{ ps}$$

$$\int_{0}^{\frac{\pi}{2}} \left[t_{pd} = 35 \text{ ps} \right]$$

$$\int_{0}^{\frac{\pi}{2}} \left[t_{cd} = 25 \text{ ps} \right]$$

$$\frac{1}{2}$$
 $t_{cd} = 25$

$t_{cd} = 25 \text{ ps}$

 t_{pd} = 3 x 35 ps = 105 ps

Setup time constraint:

$$T_c \ge (50 + 105 + 60) \text{ ps} = 215 \text{ ps}$$

$$f_c = 1/T_c = 4.65 \text{ GHz}$$

Hold time constraint:

$$t_{\text{ccq}} + t_{pd} > t_{\text{hold}}$$
?

$$(30 + 25) ps > 70 ps ? No!$$

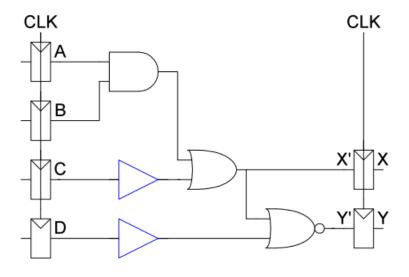


Fixing Hold Time Violation



Fixing Hold Time Violation

Add buffers to the short paths:



$$t_{pd}$$
 = 3 x 35 ps = 105 ps

$$t_{cd}$$
 = 2 x 25 ps = 50 ps

Setup time constraint:

$$T_c \ge (50 + 105 + 60) \text{ ps} = 215 \text{ ps}$$

$$f_c = 1/T_c = 4.65 \text{ GHz}$$

Timing Characteristics

$$t_{ccq}$$
 = 30 ps

$$t_{pcq} = 50 \text{ ps}$$

$$t_{\text{setup}}$$
 = 60 ps

$$t_{\text{hold}}$$
 = 70 ps

$$t_{pd} = 35 \text{ ps}$$

 $t_{cd} = 25 \text{ ps}$

Hold time constraint:

$$t_{cca} + t_{pd} > t_{hold}$$
?

$$(30 + 50) ps > 70 ps ? Yes!$$

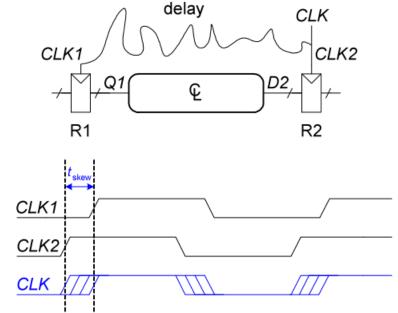


Clock Skew



Clock Skew

- The clock doesn't arrive at all registers at the same time
- Skew is the difference between two clock edges
- Examine the worst case to guarantee that the dynamic discipline is not violated for any register many registers in a system!

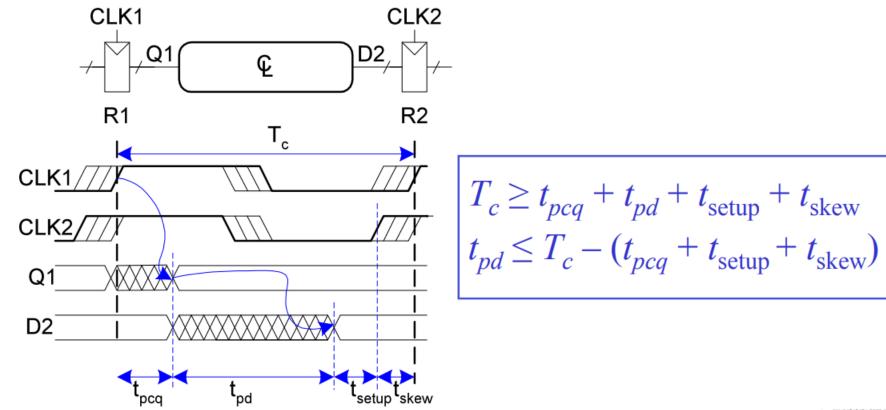


Setup Time Constraint with Clock Skew



Setup Time Constraint with Clock Skew

• In the worst case, the CLK2 is earlier than CLK1



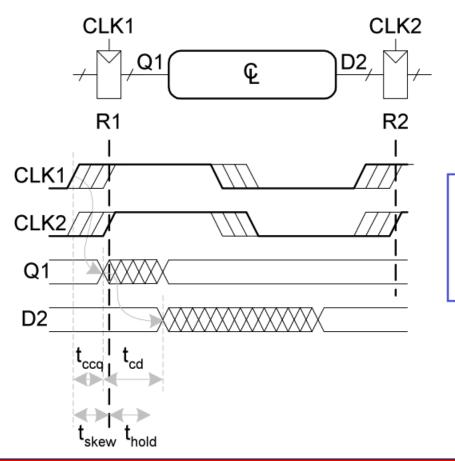
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Hold Time Constraint with Clock Skew



Hold Time Constraint with Clock Skew

• In the worst case, CLK2 is later than CLK1



$$\begin{aligned} t_{ccq} + t_{cd} &> t_{\text{hold}} + t_{\text{skew}} \\ t_{cd} &> t_{\text{hold}} + t_{\text{skew}} - t_{ccq} \end{aligned}$$

Flip Flop Max Delay Constraint



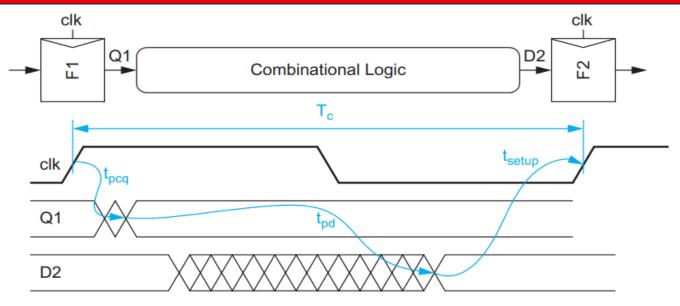


FIGURE 10.5 Flip-flop max-delay constraint

This implies that the clock period must be at least

$$T_c \ge t_{pcq} + t_{pd} + t_{\text{setup}} \tag{10.1}$$

Alternatively, we can solve for the maximum allowable logic delay, which is simply the cycle time less the sequencing overhead introduced by the propagation delay and setup time of the flip-flop.

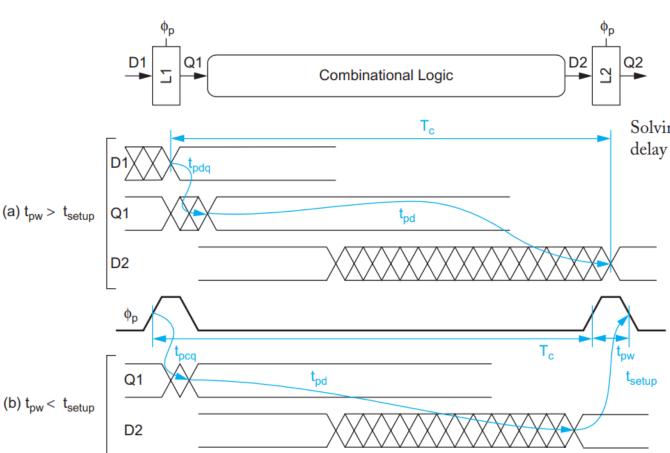
$$t_{pd} \le T_c - \left(t_{\text{setup}} + t_{pcq}\right)$$
sequencing overhead

(10.2)

Pulsed Latch Max Delay Constraint



except that only one latch is in the critical path, as shown in Figure 10.8(a). However, if the pulse is narrower than the setup time, the data must set up before the pulse rises, as shown in Figure 10.8(b). Combining these two cases gives



$$T_c \ge \max\left(t_{pdq} + t_{pd}, t_{pcq} + t_{pd} + t_{setup} - t_{pw}\right)$$
 (10.5)

Solving for the maximum logic delay shows that the sequencing overhead is just one latch delay if the pulse is wide enough to hide the setup time

$$t_{pd} \le T_c - \underbrace{\max\left(t_{pdq}, t_{peq} + t_{\text{setup}} - t_{pw}\right)}_{\text{sequencing overhead}}$$
(10.6)

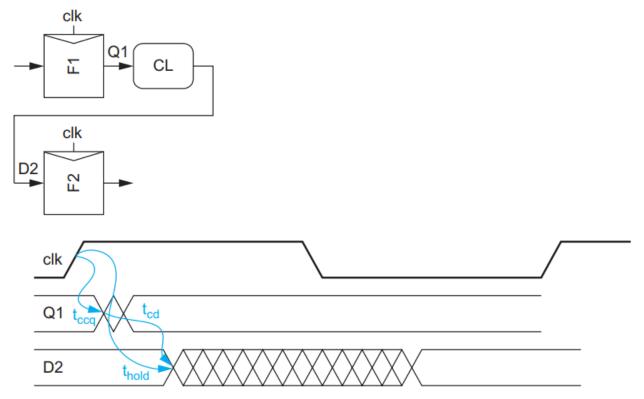
FIGURE 10.8 Pulsed latch max-delay constraint

Flip Flop / Latch Min Delay Constraint



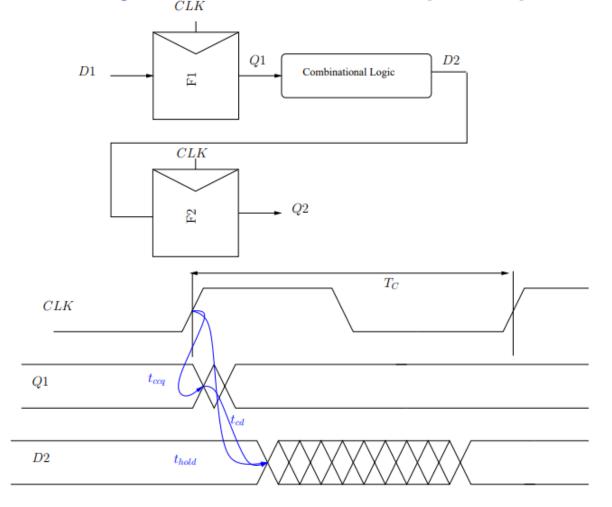
Figure 10.9 shows the min-delay timing constraints on a path from one flip-flop to the next assuming ideal clocks with no skew. The path begins with the rising edge of the clock triggering F1. The data may begin to change at Q1 after a clk-to-Q contamination delay, and at D2 after another logic contamination delay. However, it must not reach D2 until at least the hold time t_{hold} after the clock edge, lest it corrupt the contents of F2. Hence, we solve for the minimum logic contamination delay:

$$t_{cd} \ge t_{\text{hold}} - t_{ccq} \tag{10.7}$$



Min Delay Constraint DFF Min Delay Constraint - Flip Flop





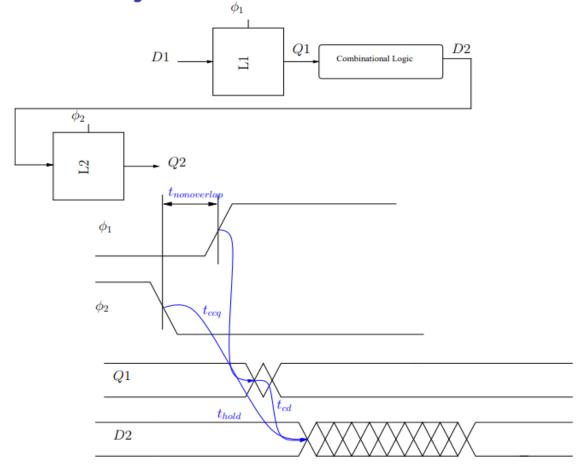
$$t_{hold} \leq t_{cd} + t_{ccq}$$

 $t_{cd} \geq t_{hold} - t_{ccq}$

Min Delay Constraint Latch



Min Delay Constraint - Latch



$$t_{hold} \leq t_{cd1}, t_{cd2} + t_{ccq} + t_{nonoverlap}$$

 $t_{cd1}, t_{cd2} \geq t_{hold} - t_{ccq} - t_{nonoverlap}$

Bidirectional I/O Pad Circuit



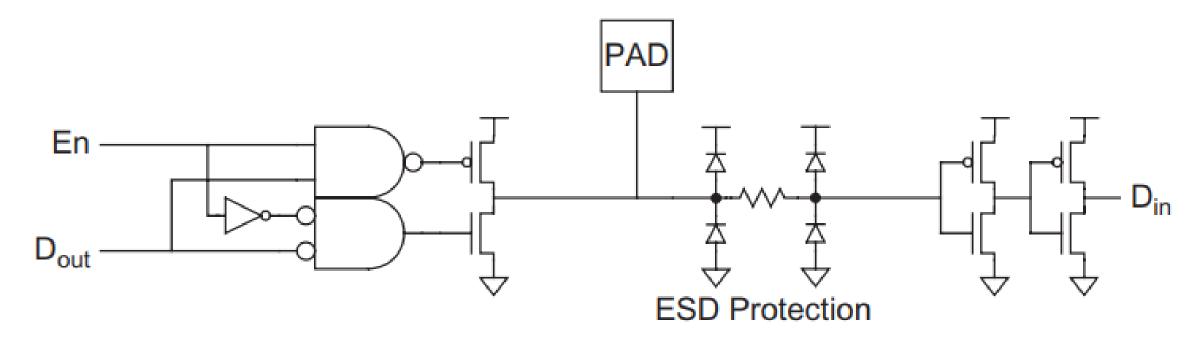
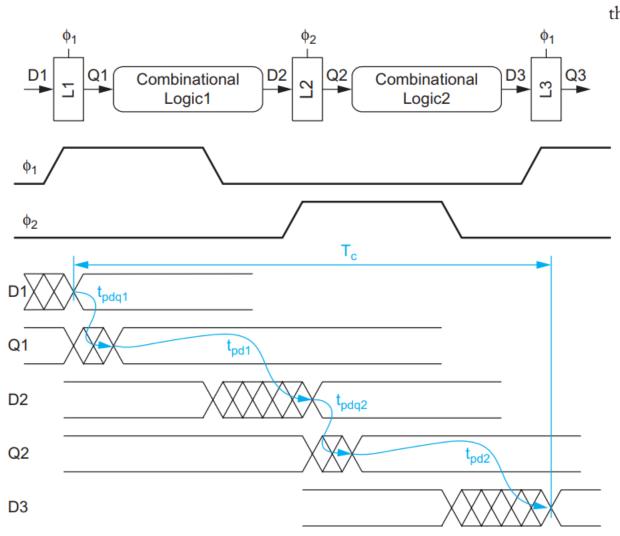


FIGURE 13.47 Bidirectional pad circuitry

Two Phase Max Delay Constraint





time borrowing and will be addressed in Section 10.2.4. Assuming the path takes no more than a cycle, we see the cycle time must be

$$T_c \ge t_{pdq1} + t_{pd1} + t_{pdq2} + t_{pd2}$$
 (10.3)

national logic between latches even while both clocks are low. Realizing that a flip-flop can be made from two latches whose delays determine the flop propagation delay and setup time, we see EQ (10.4) is closely analogous to EQ (10.2).

$$t_{pd} = t_{pd1} + t_{pd2} \le T_c - \underbrace{\left(2t_{pdq}\right)}_{\text{sequencing overhead}}$$
(10.4)

FIGURE 10.7 Two-phase latch max-delay constraint

Input Protection Circuit



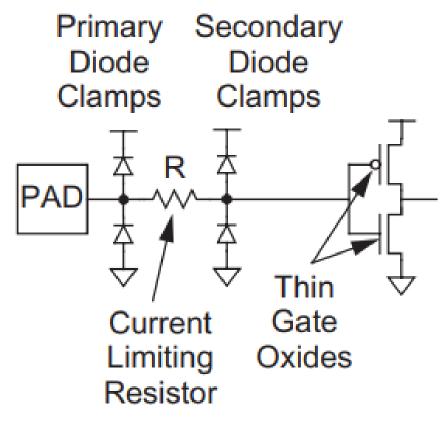


FIGURE 13.49 Input protection circuitry

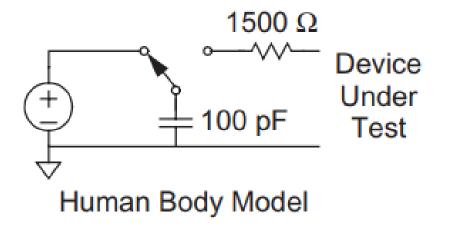
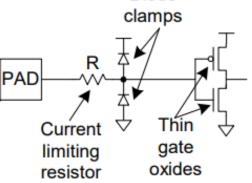


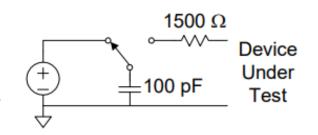
FIGURE 13.50 ESD test circuits

ESD Protection in I/O Pads



- Static electricity builds up on your body
 - Shock delivered to a chip can fry thin gates
 - Must dissipate this energy in protection circuits before it reaches the gates
- ESD protection circuits
 - Current limiting resistor
 - Diode clamps
- ESD testing
 - Human body model
 - Views human as charged capacitor





MOSIS I/O Pad Schematic



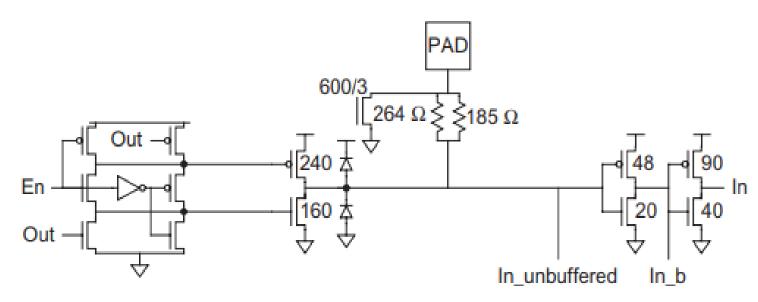


FIGURE 13.52 MOSIS bidirectional pad schematic

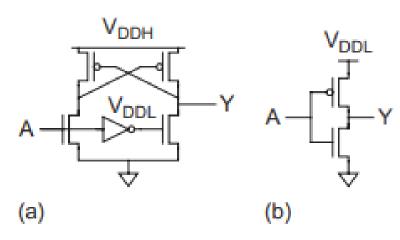
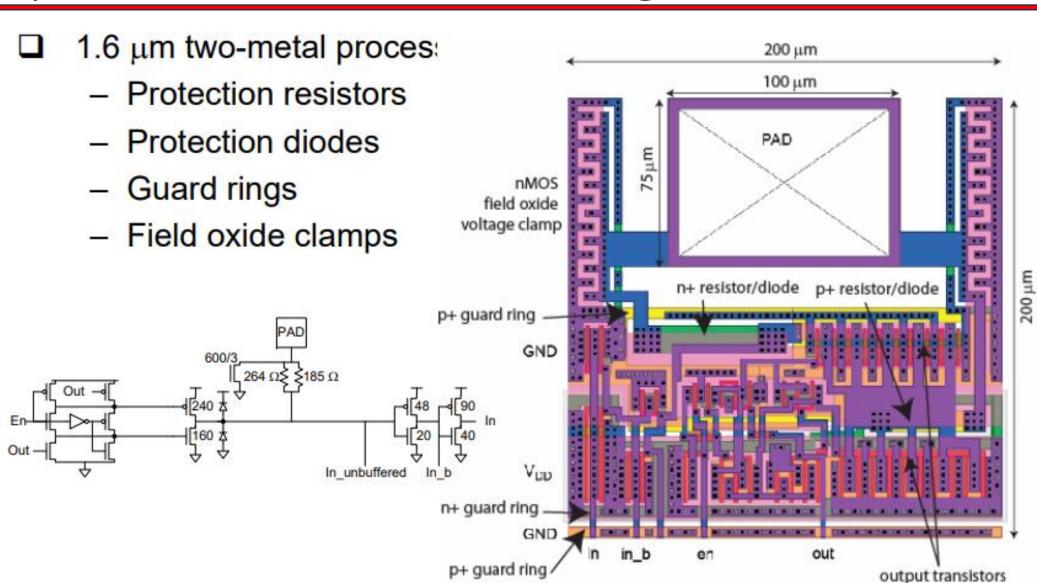


FIGURE 13.53 Level converters

Example of MOSIS I/O Pad Design

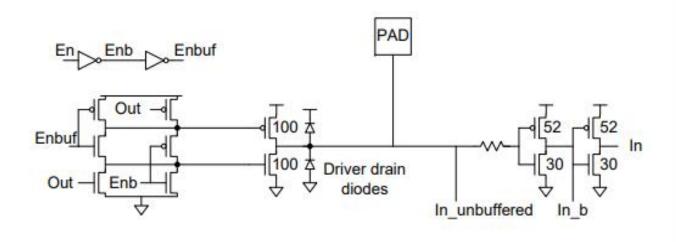


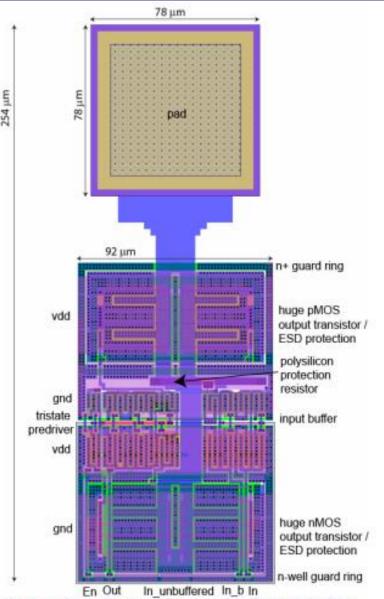


Another I/O Pad Design from Utah University



- 0.6 μm three-metal process
 - Similar I/O drivers
 - Big driver transistors provide ESD protection
 - Guard rings around driver





Readings



- Sequencing and Timing parameters are discussed in Section 10.2 of Course textbook
- I/O PADS in Chapter 13 of textbook
- Memory arrays are discussed in Chapter 12 of Course textbook